

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6195076

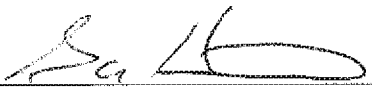
<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
GULEID HUSSEN	01/09/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	COMPONENT RE-ENGINEERING COMPANY, INC.
<b>Street Address:</b>	3508 BASSETT STREET
<b>City:</b>	SANTA CLARA
<b>State/Country:</b>	UNITED STATES
<b>Postal Code:</b>	95054
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16817627
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(831)462-8273
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	831 462-8270
<b>Email:</b>	mguth@guthpatents.com
<b>Correspondent Name:</b>	MICHAEL A. GUTH
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<b>ATTORNEY DOCKET NUMBER:</b>	1286-US-1C
<b>NAME OF SUBMITTER:</b>	MICHAEL A. GUTH
<b>SIGNATURE:</b>	/Michael A. Guth/
<b>DATE SIGNED:</b>	07/10/2020
<b>Total Attachments: 1</b>	
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**ASSIGNMENT**

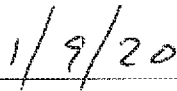
For good and valuable consideration, receipt of which is hereby acknowledged, I, Guleid Hussen, of San Francisco, California, hereby sell, assign, and transfer to Component Re-Engineering Company, Inc., a California corporation, having a place of business at 3508 Bassett Street, Santa Clara, CA 95054, its successors and assigns, the entire right, title, and interest throughout the world in my invention in

**ELECTROSTATIC CHUCK FOR CLAMPING IN HIGH TEMPERATURE SEMICONDUCTOR PROCESSING AND METHOD OF MAKING SAME**

for which I have filed a United States patent application on November 02, 2016, which now has U.S. Patent Application No. 15/341,843, and all national, regional, and international patent applications and patents of every country or region for said invention, including divisions, reissues, continuations, and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, at their request and expense, in obtaining and enforcing patents for said invention in all countries and regions; and I request the United States Patent and Trademark Office to issue all patents granted for said invention to the above-named assignee, its successors, and assigns.



Guleid Hussen



Date